SMD Transient Voltage Suppressors

MSK0402-24V

1.1 Technology Data	Symbol		Value	Unit
Maximum allowable continuous AC voltage at 50-60Hz	V_{RMS}		18	V
Maximum allowable continuous DC voltage	V_{DC}		12	V
Varistor voltage measured *1	Vv		100~150	V
Typical capacitance value measured at 1MHz	С		0.2	pF
Typical capacitance value tolerance			+80-20	%
Maximum ESD allowable clamping Voltage*2	V_{CLAMP}	<	200	V
Leakage current at V _{DC*3} (At initial state)	I _{LDC}	<	0.1	uA
Leakage current at V _{DC*3} (After ESD Test)	I _{LDCA}	<	2	uA
1.2 Reference Data				
Response time	T _{rise}	<	0.5	ns
Operation ambient temperature			-50∼ +85	$^{\circ}\!\mathbb{C}$
Storage temperature			-50∼+125	$^{\circ}\!\mathbb{C}$
ESD testing	IEC61000-4-2 level 4			
1.3 Other Data				
Body			ZnO	
End termination			Ag/Ni/Sn	
Packaging			Reel	
Complies with Standard			IEC61000-4-2	
Complies with RoHs Standard			Yes	
Lead Content		<	1000	ppm
Marking			None	

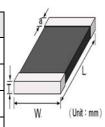
Notes:

- st 1 The varistor voltage was measured at 1 mA current
- $*\$ 2 The Clamping voltage was measured at 8*20 us standard current.
- $*$ 3 The Leakage current was measured at working voltage.
- * 4 The Energy only for customer reference.
- * 5 The components shall be employed within 1 year, in the nitrogen condition.

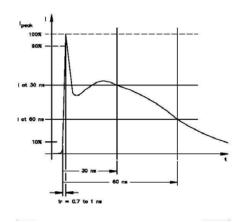


2 .Size

Model	0402(1005)	0603(1608)	0805(2012)	1206(3216)	1210(3225)	1812(4532)	2220(5750)
Length(L)	1.00 ±0.10	1.60±0.15	2.00±0.20	3.20±0.20	3.20±0.20	4.50±0.20	5.70±0.20
Width(W)	0.50 ±0.10	0.80±0.10	1.25±0.15	1.60±0.15	2.50±0.20	3.20±0.20	5.00±0.20
Thickness(T)	0.60 max	0.90 max	1.20 max	1.50 max	1.50 max	2.00 max	2.50 max
Termination(a)	0.25±0.1	0.3±0.1	0.3±0.1	0.5±0.2	0.5±0.2	0.5+0.3/-0.1	0.5+0.3/-0.1



3. ESD Wave Form



IEC61000-4-2 Standards

SEVERITY LEVEL	AIRDIRCHARGE	DIRECT DISCHARGE
1	2 KV	2 KV
2	4 KV	4 KV
3	8 KV	6 KV
4	15 KV	8 KV

IEC 61000-4-2 Compliant ESD Current Pulse Waveform

4. Environment Reliability Test

Characteristic	Test method and description				
High Temperature Storage	The specimen shall be subjected to $125 \pm 2^{\circ}\text{C}$ for 1000 ± 12 hours in a thermostatic bath without load and then stored at room temperature and normal humidity for 1 to 2 hours. The change of varistor voltage shall be within 10 $\%$.				
Temperature Cycle	The temperature cycle of specified		Temperature	Period	
	temperature shall be repeated five times and then stored at room temperature and	1	-40±3℃ 30Min	30Min±3	
	normal humidity for one or two hours. The	rs. The 2 Room 7	Room Temperature	1 hour	
	change of varistor voltage shall be within 10 % and mechanical damage shall be examined.	3	125±3℃	30Min±3	
		4	Room Temperature	1 hour	
High Temperature Load	11000+ 2 hours, the specimen shall be stored at room temperature and normal				
Damp Heat Load/ Humidity Load	9				
Low Temperature Storage The specimen should be subjected to $-40 \pm 2^{\circ}$ C, without load for 500 hours and then stored at room temperature for one or two hours. The change of varistor voltage shall be within 10 %					

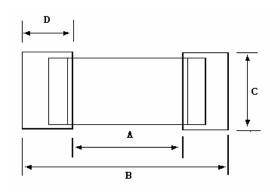


5. Soldering Recommendations

5.1 Recommended solder pad layout

(Unit: mm)

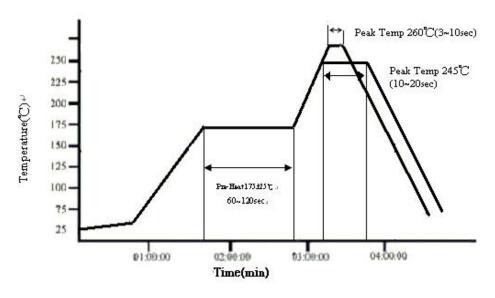
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	Α	В	С	D
0402	0.4~0.6	1.4~1.8	0.5~0.6	0.6~1.2
0603	0.9~1.2	2.7~3.2	0.7~1.0	0.9~1.2
0805	1.0~1.5	2.6~3.2	1.2~1.5	1.1~1.8
1206	1.8~2.5	4.2~5.2	1.2~1.8	1.2~1.8
1210	1.8~2.5	4.2~5.2	2.2~3.0	1.3~2.0
1812	2.5~3.3	5.5~6.7	2.8~3.6	1.3~2.2
2220	3.8~4.6	6.6~7.8	4.8~5.5	1.3~2.2



- 5.2 The SIR test of the solder paste shall be done (Based on JIS-Z-3284)
- 5.3 Steel plate and foot distance printing

Foot distance printing (mm)	Steel Plate thickness (mm)
> 0.65mm	0.18mm
0.65mm~0.5mm	0.15mm
0.50mm~0.40mm	0.12mm
>=0.40 mm	0.10mm

5.4The IR reflow and temperature of Soldering for Pb Free



☆ IR reflow Pb Free Process suggestion profile

- (1) The solder recommend is Sn96.5/Ag 3.5 of 120 to 150 μ m
- (2) Ramp-up rate (217°C to Peak) + 3°C/second max
- (3) Temp. maintain at 175 +/-25°C 180 seconds max
- (4) Temp. maintain above 217 $^{\circ}\mathrm{C}$ 60-150 seconds